



RECOMMENDED P.C.B LAYOUT
TOLERANCE:±0.05

- NOTES:**
- MATERIAL:**
 - HOUSING MATERIAL:THERMOPLASTIC UL94V-0;COLOR:BLACK
 - CONTACT MATERIAL:COPPER ALLOY,T=0.15mm
 - SHELL MATERIAL:STAINLESS STEEL,T=0.15mm
 - FINISH:**
 - CONTACT FINISH:50u" MIN.NICKEL UNDER PLATED,PLATED 3u" Au ON CONTACT AREA ;PLATED GOLD FLASH ON SOLDER AREA.
 - SHELL FINISH:50u" MIN. NICKEL UNDER PLATED, PLATED GOLD FLASH ON SOLDER AREA.
 - ELECTRICAL SPECIFICATIONS:**
 - VOLTAGE RATING:12 VAC
 - CURRENT: 1 AMPERES MAX. PER CONTACT
 - OPERATION TEMPERATURE RANGE: -25 °C ~ +70 °C
 - CONTACT RESISTANCE:60M MAX.
 - INSULATION RESISTANCE: 1000M MIN.
 - DIELECTRIC WITHSTANDING VOLTAGE:500V AC FOR 1 MINUTE
 - MAX. PROCESSING TEMP:260°C for 30 SECONDS

4.PIN ASSIGNMENT AS BELOW:

PIN NO	PIN NAME
Pin 1	Supply Voltage Vcc
Pin 2	Resrt (RST)
Pin 3	CLOCK (CLK)
Pin 5	Ground
Pin 6	Programing Voltage Vpp
Pin 7	I/O
Pin 4/8	N/A

RoHS Compliant		HSM 玄茂科技股份有限公司 HSUAN MAO TECHNOLOGY CO., LTD.	
APPD. 核准 DWG. 製圖 DATE 制表日 Betty 2021/03/24	 SCALE 比例 參考 UNIT 單位 M M PAGE 張數 1 OF 1	UNLESS OTHERWISE SPECIFIED TOLERANCES U.S. METRIC X +/- .XX X/+/- .00X FRACTIONS ANGLES +/- 0.5°	PART NAME 品名 SIM CARD BLOCK TYPE 6PIN SMT 90° ROW H=1.8mm W/O LOCATING PEG & W/O SWITCH GOLD FLASH PLATING REEL PACKING ROHS PART NO. 料號 C0634-06BAAGBRR